# Single-Channel, 128-/64-/32-Position, $\mathrm{I}^{2} \mathrm{C}, 8 \%$ Resistor Tolerance, Nonvolatile Digital Potentiometer <br> FUNCTIONAL BLOCK DIAGRAM 

## FEATURES

- Nominal resistor tolerance error: $\pm 8 \%$ maximum
- Wiper current: $\pm 6 \mathrm{~mA}$
- Rheostat mode temperature coefficient: $35 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$
- Low power consumption: $2.5 \mu \mathrm{~A}$ max @ 2.7 V and $125^{\circ} \mathrm{C}$
- Wide bandwidth: 4 MHz ( $5 \mathrm{k} \mathrm{\Omega}$ option)
- Power-on EEPROM refresh time < $50 \mu \mathrm{~s}$
- 50 -year typical data retention at $125^{\circ} \mathrm{C}$
- 1 million write cycles
- 2.3 V to 5.5 V analog supply operation
- 1.8 V to 5.5 V logic supply operation
- Wide operating temperature: $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$
- Thin, $2 \mathrm{~mm} \times 2 \mathrm{~mm} \times 0.55 \mathrm{~mm}$-lead LFCSP package


## APPLICATIONS

- Mechanical potentiometer replacement
- Portable electronics level adjustment
- Audio volume control
- Low resolution DAC
- LCD panel brightness and contrast control
- Programmable voltage to current conversion
- Programmable filters, delays, time constants
- Feedback resistor programmable power supply
- Sensor calibration


Figure 1.

## GENERAL DESCRIPTION

The AD5110/AD5112/AD5114 provide a nonvolatile solution for 128-/64-/32-position adjustment applications, offering guaranteed low resistor tolerance errors of $\pm 8 \%$ and up to $\pm 6 \mathrm{~mA}$ current density in the $A, B$, and $W$ pins. The low resistor tolerance, low nominal temperature coefficient and high bandwidth simplify openloop applications, as well as tolerance matching applications.

The new low wiper resistance feature minimizes the wiper resistance in the extremes of the resistor array to only $45 \Omega$, typical.
The wiper settings are controllable through an $\mathrm{I}^{2} \mathrm{C}$-compatible digital interface that is also used to readback the wiper register and EEPROM content. Resistor tolerance is stored within EEPROM, providing an end-to-end tolerance accuracy of $0.1 \%$.
The AD5110/AD5112/AD5114 are available in a $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ LFCSP package. The parts are guaranteed to operate over the extended industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.
Table 1. $\pm 8 \%$ Resistance Tolerance Family

| Model | Resistance (k $\Omega$ ) | Position | Interface |
| :--- | :--- | :--- | :--- |
| AD5110 | 10,80 | 128 | $I^{2} \mathrm{C}$ |
| AD5111 | 10,80 | 128 | Up/down |
| AD5112 | $5,10,80$ | 64 | $1^{2} \mathrm{C}$ |
| AD5113 | $5,10,80$ | 64 | Up/down |
| AD5114 | 10,80 | 32 | $1^{2} \mathrm{C}$ |
| AD5115 | 10,80 | 32 | Up/down |
| AD5116 | $5,10,80$ | 64 | Push-button |

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## REVISION HISTORY

1/2022—Rev. B to Rev. C
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## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS—AD5110

$10 \mathrm{k} \Omega$ and $80 \mathrm{k} \Omega$ versions: $\mathrm{V}_{\mathrm{DD}}=2.3 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {LOGIC }}=1.8 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{B}}=0 \mathrm{~V},-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.
Table 2.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS-RHEOSTAT MODE <br> Resolution <br> Resistor Integral Nonlinearity ${ }^{2}$ <br> Resistor Differential Nonlinearity ${ }^{2}$ <br> Nominal Resistor Tolerance <br> Resistance Temperature Coefficient ${ }^{3}$ Wiper Resistance | N <br> R-INL <br> R-DNL <br> $\Delta R_{A B} / R_{A B}$ <br> $\left(\Delta R_{A B} / R_{A B}\right) / \Delta T \times 10^{6}$ <br> $\mathrm{R}_{\mathrm{W}}$ <br> $\mathrm{R}_{\mathrm{BS}}$ <br> $\mathrm{R}_{\mathrm{TS}}$ | $\begin{aligned} & \mathrm{R}_{A B}=10 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{DD}}=2.3 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \\ & \mathrm{R}_{A B}=10 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{DD}}=2.7 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{R}_{A B}=80 \mathrm{k} \Omega \\ & \\ & \text { Code }=\text { full scale } \\ & \text { Code }=\text { zero scale } \\ & \text { Code }=\text { bottom scale } \\ & \text { Code }=\text { top scale } \end{aligned}$ | $\begin{array}{\|l} -2.5 \\ -1 \\ -0.5 \\ -1 \\ -8 \end{array}$ | $\pm 0.5$ $\pm 0.25$ $\pm 0.1$ $\pm 0.25$ 35 70 45 70 | $\begin{aligned} & +2.5 \\ & +1 \\ & +0.5 \\ & +1 \\ & +8 \\ & \\ & 140 \\ & 80 \\ & 140 \end{aligned}$ | Bits <br> LSB <br> LSB <br> LSB <br> LSB <br> \% <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ <br> $\Omega$ <br> $\Omega$ <br> $\Omega$ |
| DC CHARACTERISTICS-POTENTIOMETER DIVIDER MODE <br> Integral Nonlinearity ${ }^{4}$ <br> Differential Nonlinearity ${ }^{4}$ <br> Full-Scale Error <br> Zero-Scale Error <br> Voltage Divider Temperature Coefficient ${ }^{3}$ | INL <br> DNL <br> $V_{\text {WFSE }}$ <br> $V_{\text {WZSE }}$ $\left(\Delta V_{W} N_{w}\right) / \Delta T \times 10^{6}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{AB}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=80 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=80 \mathrm{k} \Omega \\ & \text { Code }=\text { half scale } \end{aligned}$ | $\begin{aligned} & -0.5 \\ & -0.5 \\ & -2.5 \\ & -1.5 \end{aligned}$ | $\pm 0.15$ <br> $\pm 0.15$ <br> $\pm 10$ | $\begin{aligned} & +0.5 \\ & +0.5 \\ & \\ & 1.5 \\ & 0.5 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { ppm/ } \end{aligned}$ |
| RESISTOR TERMINALS <br> Maximum Continuous $\mathrm{I}_{\mathrm{A}}, \mathrm{I}_{\mathrm{B}}$, and $\mathrm{I}_{\mathrm{W}}$ Current $^{3}$ <br> Terminal Voltage Range ${ }^{5}$ <br> Capacitance A, Capacitance B ${ }^{3}$ <br> Capacitance W ${ }^{3}$ <br> Common-Mode Leakage Current ${ }^{3}$ | $\begin{aligned} & C_{A}, C_{B} \\ & C_{W} \end{aligned}$ | $\begin{aligned} & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ <br> $f=1 \mathrm{MHz}$, measured to GND , code $=$ half scale, $\mathrm{V}_{\mathrm{W}}=\mathrm{V}_{\mathrm{A}}=2.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{W}}=$ $V_{B}=2.5 \mathrm{~V}$ <br> $f=1 \mathrm{MHz}$, measured to GND , code $=$ half scale, $\mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{B}}=2.5 \mathrm{~V}$ $V_{A}=V_{W}=V_{B}$ | -6 <br> -1.5 <br> GND $-500$ | 20 <br> 35 <br> $\pm 15$ | +6 <br> +1.5 <br> $V_{D D}$ $+500$ | mA <br> mA <br> V <br> pF <br> pF <br> nA |
| DIGITAL INPUTS <br> Input Logic ${ }^{3}$ <br> High <br> Low <br> Input Hysteresis ${ }^{3}$ <br> Input Current ${ }^{3}$ <br> Input Capacitance ${ }^{3}$ | $V_{\text {INH }}$ <br> $\mathrm{V}_{\text {INL }}$ <br> $\mathrm{V}_{\text {HYST }}$ <br> $I_{N}$ <br> $\mathrm{C}_{\mathrm{IN}}$ | $\begin{aligned} & V_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \end{aligned}$ | $\begin{gathered} 0.8 \times \text { V }_{\text {LOGIC }} \\ 0.7 \times \mathrm{V}_{\text {LOGIC }} \\ \\ 0.1 \times \mathrm{V}_{\text {LOGIC }} \end{gathered}$ | 5 | $\begin{aligned} & 0.2 \times V_{\text {LOGIC }} \\ & 0.3 \times V_{\text {LOGIC }} \end{aligned}$ <br> $\pm 1$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| DIGITAL OUTPUT (SDA) <br> Output Low Voltage ${ }^{3}$ <br> Three-State Leakage Current Three-State Output Capacitance ${ }^{3}$ | $V_{0 L}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{SINK}}=3 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{SINK}}=6 \mathrm{~mA} \end{aligned}$ | -1 | 2 | $\begin{aligned} & 0.2 \\ & 0.4 \\ & +1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLIES |  |  |  |  |  |  |

## SPECIFICATIONS

Table 2.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Single-Supply Power Range Logic Supply Range Positive Supply Current <br> EEMEM Store Current ${ }^{3}, 6$ <br> EEMEM Read Current ${ }^{3,7}$ <br> Logic Supply Current <br> Power Dissipation ${ }^{8}$ <br> Power Supply Rejection ${ }^{3}$ | $V_{D D}$ <br> $V_{\text {LOGIC }}$ <br> $I_{D D}$ <br> IDD_NVM_STORE <br> ldd_NVM_READ <br> logic <br> PDISS <br> PSR | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=2.7 \mathrm{~V} \\ & V_{D D}=2.3 \mathrm{~V} \\ & \\ & V_{I H}=V_{\text {LOGIC or }} V_{I L}=G N D \\ & V_{I H}=V_{\text {LOGIC or }} V_{I L}=G N D \\ & \Delta V_{D D} / \Delta V_{S S}=5 \mathrm{~V} \pm 10 \% \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 2.3 \\ & 1.8 \end{aligned}$ | $\begin{aligned} & 0.75 \\ & 2 \\ & 320 \\ & 30 \\ & 5 \\ & -50 \\ & -64 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & V_{D D} \\ & 3.5 \\ & 2.5 \\ & 2.4 \end{aligned}$ | V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mA <br> $\mu \mathrm{A}$ <br> nA <br> $\mu \mathrm{W}$ <br> dB <br> dB |
| DYNAMIC CHARACTERISTICS ${ }^{3,9}$ <br> Bandwidth <br> Total Harmonic Distortion <br> $V_{W}$ Settling Time <br> Resistor Noise Density | BW <br> THD <br> $t_{s}$ <br> $\mathrm{e}_{\mathrm{N}, \mathrm{Wb}}$ | $\begin{aligned} & -3 \mathrm{~dB}, \text { code }=\text { half scale } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & \mathrm{~V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}} / 2+1 \mathrm{~V} \text { rms, } \mathrm{V}_{B}=\mathrm{V}_{\mathrm{DD}} / 2, \mathrm{f}= \\ & 1 \mathrm{kHz}, \text { code }=\text { half scale } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & V_{A}=5 \mathrm{~V}, V_{B}=0 \mathrm{~V}, \pm 0.5 \mathrm{LSB} \text { error } \\ & \text { band } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & C o d e=\text { half scale, } \mathrm{T}_{A}=25^{\circ} \mathrm{C}, \mathrm{f}=100 \\ & \mathrm{kHz} \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & \hline \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 200 \\ & -80 \\ & -85 \\ & 3 \\ & 12 \\ & 9 \\ & 20 \end{aligned}$ |  | kHz <br> dB <br> dB <br> $\mu \mathrm{S}$ <br> $\mu \mathrm{S}$ <br> $\mathrm{nV} / \mathrm{Hzz}$ <br> $\mathrm{nV} / \mathrm{Hzz}$ |
| FLASH/EE MEMORY RELIABILITY ${ }^{3}$ <br> Endurance ${ }^{10}$ <br> Data Retention ${ }^{11}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 100 | $\begin{gathered} 1 \\ 50 \end{gathered}$ |  | MCycles <br> kCycles <br> Years |

1 Typical values represent average readings at $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
${ }^{2}$ Resistor position nonlinearity error ( $\mathrm{R}-\mathrm{NL}$ ) is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. $R$-DNL measures the relative step change from ideal between successive tap positions. The maximum wiper current is limited to $0.75 \times \mathrm{V}_{D D} / R_{A B}$.
${ }^{3}$ Guaranteed by design and characterization, not subject to production test.
${ }^{4}$ INL and $D N L$ are measured at $V_{W B}$ with the $R D A C$ configured as a potentiometer divider similar to a voltage output $D A C . V_{A}=V_{D D}$ and $V_{B}=0 V$. $D N L$ specification limits of $\pm 1$ LSB maximum are guaranteed monotonic operating conditions.
${ }^{5}$ Resistor Terminal A, Resistor Terminal B, and Resistor Terminal W have no limitations on polarity with respect to each other.
6 Different from operating current; supply current for NVM program lasts approximately 30 ms .
7 Different from operating current; supply current for NVM read lasts approximately $20 \mu \mathrm{~s}$.
${ }^{8} \mathrm{P}_{\text {DISS }}$ is calculated from ( $\left.\mathrm{I}_{D D} \times \mathrm{V}_{D D}\right)+\left(\mathrm{l}_{\text {LOGIC }} \times \mathrm{V}_{\text {LOGIC }}\right)$.
9 All dynamic characteristics use $\mathrm{V}_{D D}=5.5 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
${ }^{10}$ Endurance is qualified at 100,000 cycles per JEDEC Standard 22, Method A117 and measured at $150^{\circ} \mathrm{C}$.
${ }^{11}$ Retention lifetime equivalent at junction temperature $\left(T_{j}\right)=125^{\circ} \mathrm{C}$ per JEDEC Standard 22, Method A117. Retention lifetime based on an activation energy of 1 eV derates with junction temperature in the Flash/EE memory.

## SPECIFICATIONS

## ELECTRICAL CHARACTERISTICS—AD5112

$5 \mathrm{k} \Omega, 10 \mathrm{k} \Omega$, and $80 \mathrm{k} \Omega$ versions: $\mathrm{V}_{\mathrm{DD}}=2.3 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{LOGIC}}=1.8 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{A}}=\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{B}}=0 \mathrm{~V},-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.

Table 3.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS-RHEOSTAT MODE <br> Resolution <br> Resistor Integral Nonlinearity ${ }^{2}$ <br> Resistor Differential Nonlinearity ${ }^{2}$ Nominal Resistor Tolerance Resistance Temperature Coefficient ${ }^{3}$ Wiper Resistance | N <br> R-INL <br> R-DNL <br> $\Delta R_{A B} / R_{A B}$ <br> $\left(\Delta R_{A B} / R_{A B}\right) / \Delta T \times 10^{6}$ <br> $\mathrm{R}_{\mathrm{w}}$ <br> $R_{B S}$ <br> $\mathrm{R}_{\text {TS }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{AB}}=5 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{DD}}=2.3 \mathrm{~V} \text { to } 2.7 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{AB}}=5 \mathrm{k} \Omega, \mathrm{~V}_{\mathrm{DD}}=2.7 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{AB}}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=80 \mathrm{k} \Omega \\ & \\ & \\ & \text { Code }=\text { full scale } \\ & \text { Code }=\text { zero scale } \\ & \text { Code }=\text { bottom scale } \\ & \text { Code }=\text { top scale } \end{aligned}$ | $\begin{aligned} & -2.5 \\ & -1 \\ & -1 \\ & -0.25 \\ & +1 \\ & -8 \end{aligned}$ | $\begin{aligned} & \pm 0.5 \\ & \pm 0.25 \\ & \pm 0.25 \\ & \pm 0.1 \\ & \pm 0.25 \\ & 35 \\ & 70 \\ & 45 \\ & 70 \end{aligned}$ | $\begin{aligned} & +2.5 \\ & +1 \\ & +1 \\ & +0.25 \\ & +1 \\ & +8 \\ & \\ & 140 \\ & 80 \\ & 140 \end{aligned}$ | Bits LSB LSB LSB LSB LSB $\%$ $p p m /{ }^{\circ} C$ $\Omega$ $\Omega$ $\Omega$ |
| DC CHARACTERISTICS-POTENTIOMETER DIVIDER MODE <br> Integral Nonlinearity ${ }^{4}$ Differential Nonlinearity ${ }^{4}$ Full-Scale Error Zero-Scale Error Voltage Divider Temperature Coefficient ${ }^{3}$ | INL <br> DNL <br> $V_{\text {WFSE }}$ <br> $V_{\text {WZSE }}$ $\left(\Delta V_{W} / N_{W}\right) / \Delta T \times 10^{6}$ | $\begin{aligned} & R_{A B}=5 \mathrm{k} \mathrm{\Omega} \\ & R_{A B}=10 \mathrm{k} \mathrm{\Omega} \\ & R_{A B}=80 \mathrm{k} \mathrm{\Omega} \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \mathrm{\Omega} \\ & R_{A B}=80 \mathrm{k} \mathrm{\Omega} \\ & \text { code }=\text { half scale } \end{aligned}$ | $\begin{aligned} & -0.5 \\ & -0.5 \\ & -2.5 \\ & -1.5 \\ & -1 \end{aligned}$ | $\pm 0.15$ <br> $\pm 0.15$ <br> $\pm 10$ | $\begin{aligned} & +0.5 \\ & +0.5 \end{aligned}$ <br> 1.5 <br> 1 <br> 0.25 | LSB LSB LSB LSB LSB LSB LSB LSB ppm |
| RESISTOR TERMINALS <br> Maximum Continuous $I_{A}, l_{B}$, and $l_{W}$ Current ${ }^{3}$ <br> Terminal Voltage Range ${ }^{5}$ <br> Capacitance A, Capacitance B ${ }^{3}$ <br> Capacitance W ${ }^{3}$ <br> Common-Mode Leakage Current ${ }^{3}$ | $\mathrm{C}_{\mathrm{A}}, \mathrm{C}_{\mathrm{B}}$ <br> $c_{w}$ | $\begin{aligned} & \mathrm{R}_{A B}=5 \mathrm{k} \Omega, 10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=80 \mathrm{k} \Omega \end{aligned}$ <br> $f=1 \mathrm{MHz}$, measured to GND , code <br> $=$ half scale, $V_{W}=V_{A}=2.5 \mathrm{~V}$ or $V_{W}$ $=V_{B}=2.5 \mathrm{~V}$ <br> $f=1 \mathrm{MHz}$, measured to $G N D$, code <br> $=$ half scale, $V_{A}=V_{B}=2.5 \mathrm{~V}$ $V_{A}=V_{W}=V_{B}$ | -6 <br> -1.5 <br> GND $-500$ | 20 35 $\pm 15$ | $+6$ <br> +1.5 <br> $V_{D D}$ <br> $+500$ | mA mA <br> V <br> pF <br> pF <br> nA |
| DIGITAL INPUTS Input Logic ${ }^{3}$ High Low Input Hysteresis ${ }^{3}$ Input Current ${ }^{3}$ Input Capacitance ${ }^{3}$ | $\begin{array}{\|l} \mathrm{V}_{\mathbb{N H}} \\ \mathrm{V}_{\mathbb{N L}} \\ \mathrm{V}_{\mathrm{HYST}} \\ \mathrm{IN}_{\mathrm{N}} \\ \mathrm{C}_{\mathbb{N}} \\ \hline \end{array}$ | $\begin{aligned} & V_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \end{aligned}$ | $\begin{gathered} 0.8 \times V_{\text {Logic }} \\ 0.7 \times V_{\text {LOGGC }} \\ \\ 0.1 \times V_{\text {LoGic }} \end{gathered}$ |  | $\begin{aligned} & 0.2 \times V_{\text {LOGIC }} \\ & 0.3 \times V_{\text {LOGIC }} \end{aligned}$ <br> $\pm 1$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| DIGITAL OUTPUT (SDA) Output Low Voltage ${ }^{3}$ | Vol | $\begin{aligned} & l_{\text {SINK }}=3 \mathrm{~mA} \\ & \mathrm{I}_{\text {SINK }}=6 \mathrm{~mA} \end{aligned}$ |  |  | $\begin{aligned} & 0.2 \\ & 0.4 \end{aligned}$ |  |

## SPECIFICATIONS

Table 3.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Three-State Leakage Current Three-State Output Capacitance ${ }^{3}$ |  |  | -1 | 2 | +1 | $\begin{aligned} & \mu \mathrm{A} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLIES <br> Single-Supply Power Range Logic Supply Range Positive Supply Current <br> EEMEM Store Current ${ }^{3}$, 6 EEMEM Read Current ${ }^{3}, 7$ Logic Supply Current Power Dissipation ${ }^{8}$ Power Supply Rejection ${ }^{3}$ | $V_{D D}$ <br> $V_{\text {LOGIC }}$ <br> IDD <br> IDD_NVM_STORE <br> IDD_NVM_READ <br> ${ }^{\text {LOGIC }}$ <br> PDISS <br> PSR | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=2.7 \mathrm{~V} \\ & V_{D D}=2.3 \mathrm{~V} \\ & \\ & V_{I H}=V_{\text {LOGIC }} \text { or } V_{I L}=G N D \\ & V_{I H}=V_{\text {LOGIC }} \text { or } V_{I L}=G N D \\ & \Delta V_{D D} \Delta \Delta V_{S S}=5 \mathrm{~V} \pm 10 \% \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 2.3 \\ & 1.8 \end{aligned}$ | $\begin{aligned} & 0.75 \\ & 2 \\ & 320 \\ & 30 \\ & 5 \\ & -43 \\ & -50 \\ & -64 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & V_{D D} \\ & 3.5 \\ & 2.5 \\ & 2.4 \end{aligned}$ | V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mA <br> $\mu \mathrm{A}$ <br> nA <br> $\mu \mathrm{W}$ <br> dB <br> dB <br> dB |
| DYNAMIC CHARACTERISTICS ${ }^{3,9}$ <br> Bandwidth <br> Total Harmonic Distortion <br> $V_{W}$ Settling Time <br> Resistor Noise Density |  | $\begin{aligned} & -3 \mathrm{~dB}, \text { code }=\text { half scale } \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & V_{A}=V_{D D} / 2+1 \mathrm{Vrms}, V_{B}=V_{D D} / 2, \mathrm{f} \\ & =1 \mathrm{kHz}, \text { code }=\text { half scale } \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & V_{A}=5 \mathrm{~V}, V_{B}=0 \mathrm{~V}, \pm 0.5 \mathrm{LSB} \text { error } \\ & \text { band } \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & C o d e \\ & C_{\text {h }} \\ & 100 \mathrm{kHz} \\ & R_{A B}=5 \mathrm{k} \Omega \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & \hline \end{aligned}$ |  | 4 <br> 2 <br> 200 <br> -75 <br> -80 <br> $-85$ <br> 2.5 <br> 3 <br> 10 <br> 7 <br> 9 <br> 20 |  | $\mathrm{nV} / \mathrm{Hzz}$ <br> $\mathrm{nV} / \mathrm{Hzz}$ <br> $\mathrm{nV} / \mathrm{VHz}$ |
| FLASH/EE MEMORY RELIABILITY ${ }^{3}$ <br> Endurance ${ }^{10}$ <br> Data Retention ${ }^{11}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 100 | $\begin{aligned} & 1 \\ & 50 \end{aligned}$ |  | MCycles <br> kCycles <br> Years |

1 Typical values represent average readings at $25^{\circ} \mathrm{C}, \mathrm{VDD}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
2 Resistor position nonlinearity error (R-INL) is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. The maximum wiper current is limited to $0.75 \times V_{D D} / R_{A B}$.
${ }^{3}$ Guaranteed by design and characterization, not subject to production test.
4 INL and $D N L$ are measured at $V_{W B}$ with the RDAC configured as a potentiometer divider similar to a voltage output $D A C . V_{A}=V_{D D}$ and $V_{B}=0$ V. DNL specification limits of $\pm 1$ LSB maximum are guaranteed monotonic operating conditions.
${ }^{5}$ Resistor Terminal A, Resistor Terminal B, and Resistor Terminal W have no limitations on polarity with respect to each other.
${ }^{6}$ Different from operating current; supply current for NVM program lasts approximately 30 ms .

## SPECIFICATIONS

Table 3.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |

7 Different from operating current; supply current for NVM read lasts approximately $20 \mu$ s.
$8 \mathrm{P}_{\text {DISS }}$ is calculated from ( $\left.\mathrm{I}_{D D} \times \mathrm{V}_{D D}\right)+\left(\left(_{\text {LOGIC }} \times V_{\text {LOGIC }}\right)\right.$.
${ }^{9}$ All dynamic characteristics use $\mathrm{V}_{D D}=5.5 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
${ }^{10}$ Endurance is qualified at 100,000 cycles per JEDEC Standard 22 , Method A117 and measured at $150^{\circ} \mathrm{C}$.
${ }^{11}$ Retention lifetime equivalent at junction temperature $\left(T_{j}\right)=125^{\circ} \mathrm{C}$ per JEDEC Standard 22 , Method A117. Retention lifetime based on an activation energy of 1 eV derates with junction temperature in the Flash/EE memory.

## ELECTRICAL CHARACTERISTICS—AD5114

$10 \mathrm{k} \Omega$ and $80 \mathrm{k} \Omega$ versions: $\mathrm{V}_{D D}=2.3 \mathrm{~V}$ to $5.5 \mathrm{~V}, \mathrm{~V}_{\text {LOGIC }}=1.8 \mathrm{~V}$ to $\mathrm{V}_{D D}, \mathrm{~V}_{\mathrm{A}}=\mathrm{V}_{D D}, \mathrm{~V}_{\mathrm{B}}=0 \mathrm{~V},-40^{\circ} \mathrm{C}<\mathrm{T}_{\mathrm{A}}<+125^{\circ} \mathrm{C}$, unless otherwise noted.

## Table 4.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC CHARACTERISTICS-RHEOSTAT MODE <br> Resolution <br> Resistor Integral Nonlinearity ${ }^{2}$ <br> Resistor Differential Nonlinearity ${ }^{2}$ <br> Nominal Resistor Tolerance <br> Resistance Temperature Coefficient ${ }^{3}$ <br> Wiper Resistance | N <br> R-INL <br> R-DNL <br> $\Delta R_{A B} / R_{A B}$ <br> $\left(\Delta R_{A B} / R_{A B}\right) / \Delta T \times 10^{6}$ <br> $\mathrm{R}_{\mathrm{w}}$ <br> $\mathrm{R}_{\mathrm{BS}}$ <br> $\mathrm{R}_{\text {TS }}$ | $\begin{aligned} & \text { Code }=\text { full scale } \\ & \text { Code }=\text { zero scale } \\ & \text { Code }=\text { bottom scale } \\ & \text { Code }=\text { top scale } \end{aligned}$ | $\begin{aligned} & 5 \\ & -0.5 \\ & -0.25 \\ & -8 \end{aligned}$ | $\begin{aligned} & 35 \\ & 70 \\ & 45 \\ & 70 \end{aligned}$ | $\begin{aligned} & +0.5 \\ & +0.25 \\ & +8 \\ & 140 \\ & 80 \\ & 140 \end{aligned}$ | Bits <br> LSB <br> LSB <br> \% <br> ppm $/{ }^{\circ} \mathrm{C}$ <br> $\Omega$ <br> $\Omega$ <br> $\Omega$ |
| DC CHARACTERISTICS-POTENTIOMETER DIVIDER MODE <br> Integral Nonlinearity ${ }^{4}$ <br> Differential Nonlinearity ${ }^{4}$ <br> Full-Scale Error <br> Zero-Scale Error <br> Voltage Divider Temperature Coefficient ${ }^{3}$ | INL <br> DNL <br> VWFSE <br> $V_{\text {WZSE }}$ $\left(\Delta V_{W} / V_{W}\right) / \Delta T \times 10^{6}$ | $\begin{aligned} & \mathrm{R}_{A B}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{AB}}=80 \mathrm{k} \Omega \\ & \mathrm{R}_{A B}=10 \mathrm{k} \Omega \\ & \mathrm{R}_{A B}=80 \mathrm{k} \Omega \\ & \text { Code }=\text { half scale } \end{aligned}$ | $\begin{aligned} & -0.25 \\ & -0.25 \\ & -1 \\ & -0.5 \end{aligned}$ | $\pm 10$ | $\begin{aligned} & +0.25 \\ & +0.25 \\ & 1 \\ & 0.25 \end{aligned}$ | $\begin{aligned} & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \text { LSB } \\ & \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |
| RESISTOR TERMINALS <br> Maximum Continuous $I_{A}, I_{B}$, and $I_{W}$ Current $^{3}$ <br> Terminal Voltage Range ${ }^{5}$ <br> Capacitance A, Capacitance B ${ }^{3}$ <br> Capacitance W ${ }^{3}$ <br> Common-Mode Leakage Current ${ }^{3}$ | $\begin{aligned} & C_{A}, C_{B} \\ & C_{W} \end{aligned}$ | $\begin{aligned} & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ <br> $\mathrm{f}=1 \mathrm{MHz}$, measured to GND , code $=$ half scale, $\mathrm{V}_{\mathrm{W}}=\mathrm{V}_{\mathrm{A}}=2.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{W}}=$ $V_{B}=2.5 \mathrm{~V}$ <br> $\mathrm{f}=1 \mathrm{MHz}$, measured to GND , code $=$ half scale, $V_{A}=V_{B}=2.5 \mathrm{~V}$ $V_{A}=V_{W}=V_{B}$ | -6 <br> -1.5 <br> GND <br> $-500$ | 20 35 $\pm 15$ | +6 <br> +1.5 <br> $V_{D D}$ <br> $+500$ | mA <br> mA <br> V <br> pF <br> pF <br> nA |
| DIGITAL INPUTS <br> Input Logic ${ }^{3}$ <br> High <br> Low <br> Input Hysteresis ${ }^{3}$ Input Current ${ }^{3}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{INH}} \\ & \mathrm{~V}_{\mathrm{INL}} \\ & \mathrm{~V}_{\mathrm{HYST}} \\ & \mathrm{I}_{\mathrm{N}} \end{aligned}$ | $\begin{aligned} & \mathrm{V}_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=1.8 \mathrm{~V} \text { to } 2.3 \mathrm{~V} \\ & \mathrm{~V}_{\text {LOGIC }}=2.3 \mathrm{~V} \text { to } 5.5 \mathrm{~V} \end{aligned}$ | $\begin{gathered} 0.8 \times \text { V }_{\text {LOGIC }} \\ 0.7 \times \text { V LOGIC } \\ \\ 0.1 \times \text { V }_{\text {LOGIC }} \end{gathered}$ |  | $\begin{aligned} & 0.2 \times V_{\text {LOGIC }} \\ & 0.3 \times V_{\text {LOGIC }} \end{aligned}$ <br> $\pm 1$ | $\begin{aligned} & V \\ & V \\ & V \\ & V \\ & V \\ & \mu A \end{aligned}$ |

## SPECIFICATIONS

Table 4.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input Capacitance ${ }^{3}$ | $\mathrm{C}_{\text {IN }}$ |  |  | 5 |  | pF |
| DIGITAL OUTPUT (SDA) Output Low Voltage ${ }^{3}$ <br> Three-State Leakage Current Three-State Output Capacitance ${ }^{3}$ | $\mathrm{V}_{\mathrm{OL}}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{SINK}}=3 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{SINK}}=6 \mathrm{~mA} \end{aligned}$ | -1 | 2 | $\begin{aligned} & 0.2 \\ & 0.4 \\ & +1 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| POWER SUPPLIES <br> Single-Supply Power Range Logic Supply Range Positive Supply Current <br> EEMEM Store Current ${ }^{3}, 6$ EEMEM Read Current ${ }^{3,7}$ Logic Supply Current Power Dissipation ${ }^{8}$ Power Supply Rejection ${ }^{3}$ | $V_{D D}$ <br> $V_{\text {LOGIC }}$ <br> lod <br> IDD_NVM_STORE <br> IDD_NVM_READ <br> LOGIC <br> PDISS <br> PSR | $\begin{aligned} & V_{D D}=5 \mathrm{~V} \\ & V_{D D}=2.7 \mathrm{~V} \\ & V_{D D}=2.3 \mathrm{~V} \\ & \\ & V_{I H}=V_{\text {LOGIC or }} V_{I L}=G N D \\ & V_{I H}=V_{\text {LOGIC }} \text { or } V_{I L}=G N D \\ & \Delta V_{D D} / \Delta V_{S S}=5 \mathrm{~V} \pm 10 \% \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & 2.3 \\ & 1.8 \end{aligned}$ | $\begin{aligned} & 0.75 \\ & 2 \\ & 220 \\ & 30 \\ & 5 \\ & -50 \\ & -64 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & V_{D D} \\ & 3.5 \\ & 2.5 \\ & 2.4 \end{aligned}$ | V <br> V <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mA <br> $\mu \mathrm{A}$ <br> nA <br> $\mu \mathrm{W}$ <br> dB <br> dB |
| DYNAMIC CHARACTERISTICS ${ }^{3,9}$ <br> Bandwidth <br> Total Harmonic Distortion | BW | $\begin{aligned} & -3 \mathrm{~dB}, \text { code }=\text { half scale } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & V_{A}=V_{D D} / 2+1 \mathrm{Vms}, V_{B}=V_{D D} / 2, \mathrm{f} \\ & =1 \mathrm{kHz}, \text { code }=\text { half scale } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ |  | $\begin{aligned} & 2 \\ & 200 \\ & \\ & -80 \\ & -85 \end{aligned}$ |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{kHz} \\ & \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |
| $V_{W}$ Settling Time Resistor Noise Density | $\mathrm{t}_{\mathrm{s}}$ <br> $\mathrm{e}_{\mathrm{N}, \mathrm{WB}}$ | $\begin{aligned} & V_{A}=5 \mathrm{~V}, V_{B}=0 \mathrm{~V}, \pm 0.5 \mathrm{LSB} \text { error } \\ & \text { band } \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \\ & \mathrm{Code}=\text { half scale, } \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{f}= \\ & 100 \mathrm{kHz} \\ & R_{A B}=10 \mathrm{k} \Omega \\ & R_{A B}=80 \mathrm{k} \Omega \end{aligned}$ |  | 2.7 <br> 9.5 <br> 9 <br> 20 |  | $\mu \mathrm{S}$ $\mu \mathrm{S}$ <br> $\mathrm{nV} / \mathrm{JHz}$ <br> $\mathrm{nV} / \mathrm{VHz}$ |
| FLASH/EE MEMORY RELIABILITY ${ }^{3}$ <br> Endurance ${ }^{10}$ <br> Data Retention ${ }^{11}$ |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 100 | 1 <br> 50 |  | MCycles <br> kCycles <br> Years |

1 Typical values represent average readings at $25^{\circ} \mathrm{C}, \mathrm{V}_{D D}=5 \mathrm{~V}, \mathrm{~V}_{S S}=0 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
2 Resistor position nonlinearity error ( $\mathrm{R}-\mathrm{NL}$ ) is the deviation from an ideal value measured between the maximum resistance and the minimum resistance wiper positions. R-DNL measures the relative step change from ideal between successive tap positions. The maximum wiper current is limited to $0.75 \times V_{D D} / R_{A B}$.
${ }^{3}$ Guaranteed by design and characterization, not subject to production test.
4 INL and $D N L$ are measured at $V_{W B}$ with the RDAC configured as a potentiometer divider similar to a voltage output $D A C . V_{A}=V_{D D}$ and $V_{B}=0$ V. DNL specification limits of $\pm 1$ LSB maximum are guaranteed monotonic operating conditions.
${ }^{5}$ Resistor Terminal A, Resistor Terminal B, and Resistor Terminal W have no limitations on polarity with respect to each other.
${ }^{6}$ Different from operating current; supply current for NVM program lasts approximately 30 ms .

## SPECIFICATIONS

Table 4.

| Parameter | Symbol | Test Conditions/Comments | Min | Typ ${ }^{1}$ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |

7 Different from operating current; supply current for NVM read lasts approximately $20 \mu$ s.
$8 \mathrm{P}_{\text {DISS }}$ is calculated from ( $\left.\mathrm{I}_{D D} \times \mathrm{V}_{D D}\right)+\left(\left(_{\text {LOGIC }} \times V_{\text {LOGIC }}\right)\right.$.
${ }^{9}$ All dynamic characteristics use $\mathrm{V}_{D D}=5.5 \mathrm{~V}$, and $\mathrm{V}_{\text {LOGIC }}=5 \mathrm{~V}$.
${ }^{10}$ Endurance is qualified at 100,000 cycles per JEDEC Standard 22 , Method A117 and measured at $150^{\circ} \mathrm{C}$.
${ }^{11}$ Retention lifetime equivalent at junction temperature $\left(T_{J}\right)=125^{\circ} \mathrm{C}$ per JEDEC Standard 22 , Method A117. Retention lifetime based on an activation energy of 1 eV derates with junction temperature in the Flash/EE memory.

## INTERFACE TIMING SPECIFICATIONS

$V_{\text {LOGIC }}=1.8 \mathrm{~V}$ to 5.5 V ; all specifications $\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\text {MAX }}$, unless otherwise noted.

## Table 5.



1 Maximum bus capacitance is limited to 400 pF .

## SPECIFICATIONS

Table 5.


## SHIFT REGISTER AND TIMING DIAGRAM



Figure 2. Input Register Content


Figure 3. 2-Wire Serial Interface Timing Diagram

## ABSOLUTE MAXIMUM RATINGS

$T_{A}=25^{\circ} \mathrm{C}$, unless otherwise noted.

Table 6.

| Parameter | Rating |
| :---: | :---: |
| $V_{\text {DD }}$ to GND | -0.3 V to +7.0 V |
| VLOGIC to GND | -0.3 V to +7.0 V |
| $V_{A}, V_{W}, V_{B}$ to $\mathrm{GND}^{\text {d }}$ | GND -0.3V to $\mathrm{V}_{\text {DD }}+0.3 \mathrm{~V}$ |
| $I_{A}, I_{W}, I_{B}$ <br> Pulsed ${ }^{1}$ |  |
| Frequency > 10 kHz |  |
| $\mathrm{R}_{\mathrm{AW}}=5 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega^{2}$ | $\pm 6 \mathrm{~mA} / \mathrm{d}$ |
| $\mathrm{R}_{\text {AW }}=80 \mathrm{k} \Omega^{2}$ | $\pm 1.5 \mathrm{~mA} / \mathrm{d}$ |
| Frequency $\leq 10 \mathrm{kHz}$ |  |
| $\mathrm{R}_{\mathrm{AW}}=5 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega^{2}$ | $\pm 6 \mathrm{~mA} / \sqrt{ } \mathrm{d}$ |
| $\mathrm{R}_{\mathrm{AW}}=80 \mathrm{k} \Omega^{2}$ | $\pm 1.5 \mathrm{~mA} / \mathrm{ld}$ |
| Continuous |  |
| $\mathrm{R}_{\mathrm{AW}}=5 \mathrm{k} \Omega$ and $10 \mathrm{k} \Omega$ | $\pm 6 \mathrm{~mA}$ |
| $\mathrm{R}_{\text {AW }}=80 \mathrm{k} \Omega$ | $\pm 1.5 \mathrm{~mA}$ |
| Digital Inputs SDA and SCL | $\begin{aligned} & -0.3 \mathrm{~V} \text { to }+7 \mathrm{~V} \text { or } \mathrm{V}_{\text {LOGIC }}+0.3 \mathrm{~V} \\ & \text { (whichever is less) } \end{aligned}$ |
| Operating Temperature Range ${ }^{3}$ | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Maximum Junction Temperature ( $\mathrm{T}_{\mathrm{J}} \mathrm{Max}$ ) | $150^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Reflow Soldering |  |
| Peak Temperature | $260^{\circ} \mathrm{C}$ |
| Time at Peak Temperature | 20 sec to 40 sec |
| Package Power Dissipation | $\left(T_{j} \max -\mathrm{T}_{\mathrm{A}}\right) / \theta_{j A}$ |

${ }^{1}$ Maximum terminal current is bounded by the maximum current handling of the switches, maximum power dissipation of the package, and maximum applied voltage across any two of the $\mathrm{A}, \mathrm{B}$, and W terminals at a given resistance.
2 d is the pulse duty factor.
${ }^{3}$ Includes programming of EEPROM memory.
Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

$\theta_{\mathrm{JA}}$ is defined by JEDEC specification JESD-51, and the value is dependent on the test board and test environment.

Table 7. Thermal Resistance

| Package Type | $\theta_{\text {JA }}$ | $\theta_{\text {JC }}$ | Unit |
| :--- | :--- | :--- | :--- |
| 8-Lead LFCSP | $90^{1}$ | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| 1 JEDEC 2S2P test board, still air (0 m/sec air flow). |  |  |  |

## ESD CAUTION

|  | ESD (electrostatic discharge) sensitive device. Charged devi- <br> ces and circuit boards can discharge without detection. Although <br> this product features patented or proprietary protection circuitry, <br> damage may occur on devices subjected to high energy ESD. <br> Therefore, proper ESD precautions should be taken to avoid <br> performance degradation or loss of functionality. |
| :--- | :--- |

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Figure 4. Pin Configuration

Table 8. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :---: | :---: | :---: |
| 1 | $V_{D D}$ | Positive Power Supply; 2.3 V to 5.5 V . This pin should be decoupled with $0.1 \mu \mathrm{~F}$ ceramic capacitors and $10 \mu \mathrm{~F}$ capacitors. |
| 2 | A | Terminal A of RDAC. GND $\leq \mathrm{V}_{\mathrm{A}} \leq \mathrm{V}_{\mathrm{DD}}$. |
| 3 | W | Wiper Terminal of RDAC. GND $\leq \mathrm{V}_{W} \leq \mathrm{V}_{\mathrm{DD}}$. |
| 4 | B | Terminal B of RDAC. GND $\leq \mathrm{V}_{B} \leq \mathrm{V}_{\mathrm{DD}}$. |
| 5 | GND | Ground Pin, Logic Ground Reference. |
| 6 | SCL | Serial Clock Line. This pin is used in conjunction with the SDA line to clock data into or out of the 16-bit input registers. |
| 7 | SDA | Serial Data Line. This pin is used in conjunction with the SCL line to clock data into or out of the 16 -bit input registers. It is a bidirectional, open-drain data line that should be pulled to the supply with an external pull-up resistor. |
| 8 | $V_{\text {LOGIC }}$ <br> EPAD | Logic Power Supply; 1.8 V to $\mathrm{V}_{\mathrm{DD}}$. This pin should be decoupled with $0.1 \mu \mathrm{~F}$ ceramic capacitors and $10 \mu \mathrm{~F}$ capacitors. Exposed Pad. The exposed pad is internally floating. |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 5. R-INL vs. Code (AD5110)


Figure 6. R-INL vs. Code (AD5112)


Figure 7. R-INL vs. Code (AD5114)


Figure 8. R-DNL vs. Code (AD5110)


Figure 9. R-DNL vs. Code (AD5112)


Figure 10. R-DNL vs. Code (AD5114)

TYPICAL PERFORMANCE CHARACTERISTICS


Figure 11. INL vs. Code (AD5110)


Figure 12. INL vs. Code (AD5112)


Figure 13. INL vs. Code (AD5114)


Figure 14. DNL vs. Code (AD5110)


Figure 15. DNL vs. Code (AD5112)


Figure 16. DNL vs. Code (AD5114)

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 17. Supply Current vs. Temperature


Figure 18. Potentiometer Mode Tempco $\left(\left(\Delta V_{W} / V_{W}\right) / \Delta T \times 10^{6}\right)$ vs. Code


Figure $19.5 \mathrm{k} \Omega$ Gain vs. Frequency vs. Code


Figure 20. Supply Current (llogic) vs. Digital Input Voltage


Figure 21. Rheostat Mode Tempco $\left(\left(\Delta R_{W B} / R_{W B}\right) / \Delta T \times 10^{6}\right)$ vs. Code


Figure $22.10 \mathrm{k} \Omega$ Gain vs. Frequency vs. Code

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure $23.80 \mathrm{k} \Omega$ Gain vs. Frequency vs. Code


Figure 24. Normalized Phase Flatness vs. Frequency


Figure 25. Total Harmonic Distortion + Noise ( $T H D+N$ ) vs. Frequency


Figure 26. Maximum Bandwidth vs. Code vs. Net Capacitance


Figure 27. Incremental Wiper On Resistance vs. $V_{D D}$


Figure 28. Total Harmonic Distortion + Noise (THD $+N$ ) vs. Amplitude

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 29. Maximum Transition Glitch


Figure 30. Resistor Lifetime Drift


Figure 31. Power Supply Rejection Ratio (PSRR) vs. Frequency


Figure 32. Digital Feedthrough


Figure 33. Shutdown Isolation vs. Frequency


Figure 34. Theoretical Maximum Current vs. Code

## TEST CIRCUITS

Figure 35 to Figure 40 define the test conditions used in the Specifications section.


Figure 35. Resistor Position Nonlinearity Error (Rheostat Operation: R-INL, R-DNL)


Figure 36. Potentiometer Divider Nonlinearity Error (INL, DNL)


Figure 37. Wiper Resistance


Figure 38. Power Supply Sensitivity (PSS, PSRR)


Figure 39. Gain and Phase vs. Frequency


Figure 40. Common-Mode Leakage Current

## THEORY OF OPERATION

The AD5110/AD5112/AD5114 digital programmable resistors are designed to operate as true variable resistors for analog signals within the terminal voltage range of $G N D<V_{T E R M}<V_{D D}$. The resistor wiper position is determined by the RDAC register contents. The RDAC register acts as a scratchpad register that allows unlimited changes of resistance settings.

The RDAC register can be programmed with any position setting using the ${ }^{2} C$ interface. Once a desirable wiper position is found, this value can be stored in the EEPROM memory. Thereafter, the wiper position is always restored to that position for subsequent power-up. The storing of EEPROM data takes approximately 18 ms ; during this time, the device is locked and does not acknowledge any new command, thus preventing any changes from taking place.

## RDAC REGISTER AND EEPROM

The RDAC register directly controls the position of the digital potentiometer wiper. For example, when the RDAC register is loaded with $0 \times 3 F$ ( 128 -taps), the wiper is connected to full scale of the variable resistor. The RDAC register is a standard logic register; there is no restriction on the number of changes allowed.

It is possible to both write to and read from the RDAC register using the ${ }^{2}$ C interface (see Table 10).
The contents of the RDAC register can be stored to the EEPROM using Command 1 (Table 10). Thereafter, the RDAC register is always set at that position for any future on-off-on power supply sequence. It is possible to read back the data saved into the EEPROM with Command 6 in Table 10. In addition, the resistor tolerance error is saved within the EEPROM; this can be read back and used to calculate the end-to-end tolerance, providing an accuracy of $0.1 \%$.

## Low Wiper Resistance Feature

The AD5110/AD5112/AD5114 include extra steps to achieve a minimum resistance between Terminal $W$ and Terminal A or Terminal B. These extra steps are called bottom scale and top scale. At bottom scale, the typical wiper resistance decreases from $70 \Omega$ to $45 \Omega$. At top scale, the resistance between Terminal A and Terminal W is decreased by 1 LSB, and the total resistance is reduced to $70 \Omega$. The extra steps are not equal to 1 LSB and are not included in the INL, DNL, R-INL, and R-DNL specifications.

## $I^{2} \mathrm{C}$ SERIAL DATA INTERFACE

The AD5110/AD5112/AD5114 have 2 -wire $I^{2} \mathrm{C}$-compatible serial interfaces. These devices can be connected to an $1^{2} \mathrm{C}$ bus as a slave device under the control of a master device. See Figure 3 for a timing diagram of a typical write sequence.

The AD5110/AD5112/AD5114 support standard ( 100 kHz ) and fast ( 400 kHz ) data transfer modes. Support is not provided for 10-bit addressing and general call addressing.

The 2-wire serial bus protocol operates as follows:

1. The master initiates data transfer by establishing a start condition, which is when a high-to-low transition on the SDA line occurs while SCL is high. The following byte is the address byte, which consists of the 7 -bit slave address and an R/W bit. The slave device corresponding to the transmitted address responds by pulling SDA low during the ninth clock pulse (this is termed the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to, or read from, its shift register.
2. If the $R \bar{W}$ bit is set high, the master reads from the slave device. However, if the R/W bit is set low, the master writes to the slave device.
3. Data is transmitted over the serial bus in sequences of nine clock pulses (eight data bits followed by an acknowledge bit). The transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL.
4. When all data bits have been read or written, a stop condition is established. In write mode, the master pulls the SDA line high during the $10^{\text {th }}$ clock pulse to establish a stop condition. In read mode, the master issues a no acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master brings the SDA line low before the $10^{\text {th }}$ clock pulse, and high during the $10^{\text {th }}$ clock pulse to establish a stop condition.

## $I^{2} \mathrm{C}$ Address

The AD5110/AD5112/AD5114 each have two different slave address options available. See Table 9 for a list of slave addresses.

Table 9. Device Address Selection

| Model | 7-Bit ${ }^{2}$ C Device Address |
| :--- | :--- |
| AD511X ${ }^{1}$ BCPZ Y |  |
| AD511X ${ }^{1}$ BCPZ Y2 -1 | 0101111 |

${ }^{1}$ Model.
2 Resistance.

## INPUT SHIFT REGISTER

For the AD5110/AD5112/AD5114, the input shift register is 16 bits wide (see Figure 2). The 16-bit word consists of five unused bits (should be set to zero), followed by three control bits, and eight RDAC data bits. If the RDAC register is read from or written to in the AD5112, Bit DBO is a don't care. The RDAC register is read from or written to in the AD5114, Bit DB0 and DB1 are don't cares. Data is loaded MSB first (Bit DB15). The three control bits determine the function of the software command (Table 10). Figure 3 shows a timing diagram of a typical AD5110/AD5112/AD5114 write sequence.

The command bits ( Cx ) control the operation of the digital potentiometer and the internal EEPROM. The data bits (Dx) are the values that are loaded into the decoded register.

## THEORY OF OPERATION

Table 10. Command Operation Truth Table


1 X is don't care.
2 In the AD5114, this bit is a don't care.
${ }^{3}$ In the AD5112, this bit is a don't care.

## THEORY OF OPERATION

## WRITE OPERATION

When writing to the AD5110/AD5112/AD5114, the user must begin with a start command followed by an address byte ( $\mathrm{R} / \overline{\mathrm{W}}=0$ ), after which the AD5110/AD5112/AD5114 acknowledge that it is prepared to receive data by pulling SDA low.
Two bytes of data are then written to the DAC, the most significant byte, followed by the least significant byte. Both of these data bytes
are acknowledged by the AD5110/AD5112/AD5114. A stop condition follows. The write operations for the AD5110/AD5112/AD5114 are shown in Figure 41, Figure 42, and Figure 43.
A repeated write function gives the user flexibility to update the device a number of times after addressing the part only once, as shown in Figure 44.


Figure 41. AD5110 Interface Write Command


Figure 42. AD5112 Interface Write Command


Figure 43. AD5114 Interface Write Command

## THEORY OF OPERATION



Figure 44. AD5110 Interface Multiple Write

## THEORY OF OPERATION

## EEPROM WRITE ACKNOWLEDGE POLLING

After each write operation to the EEPROM, an internal write cycle begins. The $I^{2} \mathrm{C}$ interface of the device is disabled. To determine if the internal write cycle is complete and the $I^{2} \mathrm{C}$ interface is enabled, interface polling can be executed. $I^{2} \mathrm{C}$ interface polling can be conducted by sending a start condition, followed by the slave address and the write bit. If the $I^{2} \mathrm{C}$ interface responds with an acknowledge, the write cycle is complete, and the interface is ready to proceed with further operations. Otherwise, $I^{2} \mathrm{C}$ interface polling can be repeated until it succeeds.

## READ OPERATION

The AD5110/AD5112/AD5114 allow read back of the contents of the RDAC register and EEPROM memory through the $I^{2} C$ interface by using Command 6 (see Table 10).

When reading data back from the AD5110/AD5112/AD5114, the user must first issue a readback command to the device. This
begins with a start command, followed by an address byte $(R / \bar{W}=$ 0 ), after which the AD5110/AD5112/AD5114 acknowledges that it is prepared to receive data by pulling SDA low.
Two bytes of data are then written to the AD5110/AD5112/AD5114, the most significant byte followed by the least significant byte. Both of these data bytes are acknowledged by the AD5110/AD5112/ AD5114. A stop condition follows. These bytes contain the read instruction, which enables read back of the RDAC register, EEPROM memory. The user can then read back the data. This begins with a start command followed by an address byte ( $R \bar{W}=1$ ), after which the device acknowledges that it is prepared to transmit data by pulling SDA low. Two bytes of data are then read from the device, which are both acknowledged by the master, as shown in Figure 45. A stop condition follows. If the master does not acknowledge the first byte, then the second byte is not transmitted by the AD5110/AD5112/AD5114.
The AD5110/AD5112/AD5114 do not support repeat readback.


Figure 45. AD5110 Interface Read Command

## THEORY OF OPERATION

## RESET

The AD5110/AD5112/AD5114 can be reset by executing Command 4 (see Table 10). The reset command loads the RDAC register with the contents of the EEPROM and takes approximately 25 $\mu s$. EEPROM is pre-loaded to midscale at the factory, and initial power-up is, accordingly, at midscale.

## SHUTDOWN MODE

The AD5110/AD5112/AD5114 can be shut down by executing the software shutdown command, Command 3 (see Table 10). This feature places the RDAC in a zero-power-consumption state where Terminal A is open-circuited and the wiper, Terminal W is connected to Terminal $B$ but a finite wiper resistance of $45 \Omega$ is present. The part can be taken out of shutdown mode by executing Command 3 (see Table 10) and setting Bit DBO to 0 .

## RDAC ARCHITECTURE

To achieve optimum performance, Analog Devices, Inc., has patented the RDAC segmentation architecture for all the digital potentiometers. In particular, the AD5110/AD5112/AD5114 employ a two-stage segmentation approach as shown in Figure 46. The AD5110/AD5112/AD5114 wiper switch is designed with the transmission gate CMOS topology and with the gate voltage derived from $V_{D D}$.


Figure 46. AD5110/AD5112/AD5114 Simplified RDAC Circuit

## Top Scale/Bottom Scale Architecture

In addition, the AD5110/AD5112/AD5114 include a new feature to reduce the resistance between terminals. These extra steps are called bottom scale and top scale. At bottom scale, the typical wiper resistance decreases from $70 \Omega$ to $45 \Omega$. At top scale, the resistance between Terminal A and Terminal W is decreased by 1 LSB, and the total resistance is reduced to $70 \Omega$. The extra steps are not equal to 1 LSB and are not included in the INL, DNL, R-INL, and R-DNL specifications.

## PROGRAMMING THE VARIABLE RESISTOR

## Rheostat Operation- $\pm 8 \%$ Resistor Tolerance

The AD5110/AD5112/AD5114 operate in rheostat mode when only two terminals are used as a variable resistor. The unused terminal can be floating or tied to the Terminal $W$ as shown in Figure 47.


Figure 47. Rheostat Mode Configuration
The nominal resistance between Terminal A and Terminal $B, R_{A B}$, is available in $5 \mathrm{k} \Omega, 10 \mathrm{k} \Omega$, and $80 \mathrm{k} \Omega$ and has 32/64/128 tap points accessed by the wiper terminal. The $5-16-17$-bit data in the RDAC latch is decoded to select one of the $32 / 64 / 128$ possible wiper settings. The general equations for determining the digitally programmed output resistance between the $W$ terminal and $B$ terminal are

## AD5110:

$R_{W B}=R_{B S} \quad$ Bottom scale (0xFF)
$R_{W B}(D)=\frac{D}{128} \times R_{A B}+R_{W} \quad$ From $0 \times 00$ to $0 \times 80$
AD5112:
$R_{W B}=R_{B S} \quad$ Bottom scale ( 0 xFF )
$R_{W B}(D)=\frac{D}{64} \times R_{A B}+R_{W} \quad$ From $0 \times 00$ to $0 \times 40$
AD5114:
$R_{W B}=R_{B S} \quad$ Bottom scale ( 0 xFF )
$R_{W B}(D)=\frac{D}{32} \times R_{A B}+R_{W} \quad$ From $0 \times 00$ to $0 \times 20$
where:
$D$ is the decimal equivalent of the binary code in the $5-16-17$-bit RDAC register.
$R_{A B}$ is the end-to-end resistance.
$R_{w}$ is the wiper resistance.
$R_{B S}$ is the wiper resistance at bottom scale
Similar to the mechanical potentiometer, the resistance of the RDAC between the W terminal and the A terminal also produces a digitally controlled complementary resistance, $R_{\text {WA }}$. $R_{\text {WA }}$ also gives a maximum of $8 \%$ absolute resistance error. R R $_{\text {WA }}$ starts at the maximum resistance value and decreases as the data loaded into the latch increases. The general equations for this operation are

AD5110:
$R_{A W}=R_{A B}+R_{W} \quad$ Bottom scale ( 0 xFF )
$R_{A W}(D)=\frac{128-D}{128} \times R_{A B}+R_{W} \quad$ From $0 \times 00$ to $0 \times 7 \mathrm{~F}$

## THEORY OF OPERATION

$R_{A W}=R_{T S} \quad$ Top scale ( $0 \times 80$ )
(9) then,
tolerance $=-10.25 \%$ and, therefore, $\mathrm{R}_{\mathrm{AB}}=8.975 \mathrm{k} \Omega$

## PROGRAMMING THE POTENTIOMETER DIVIDER

## Voltage Output Operation

The digital potentiometer easily generates a voltage divider at wiper-to-B and wiper-to-A that is proportional to the input voltage at $A$ to $B$, as shown in Figure 48. Unlike the polarity of $V_{D D}$ to $G N D$, which must be positive, voltage across A-to-B, W-to-A, and W-to-B can be at either polarity.


Figure 48. Potentiometer Mode Configuration
Connecting Terminal A to 5 V and Terminal B to ground produces an output voltage at the Wiper W to Terminal B ranging from 0 V to 5 V . The general equation defining the output voltage at $\mathrm{V}_{\mathrm{w}}$ with respect to ground for any valid input voltage applied to Terminal A and Terminal B, is:
$V_{W}(D)=\frac{R_{W B}(D)}{R_{A B}} \times V_{A}+\frac{R_{A W}(D)}{R_{A B}} \times V_{B}$
where:
$R_{\text {WB }}(D)$ can be obtained from Equation 1 to Equation 6.
$R_{\text {Aw }}(D)$ can be obtained from Equation 7 to Equation 15.
Operation of the digital potentiometer in the divider mode results in a more accurate operation over temperature. Unlike the rheostat mode, the output voltage is dependent mainly on the ratio of the internal resistors, $\mathrm{R}_{\mathrm{AW}}$ and $\mathrm{R}_{\mathrm{WB}}$, and not the absolute values.
Therefore, the temperature drift reduces to $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$.

## TERMINAL VOLTAGE OPERATING RANGE

The AD5110/AD5112/AD5114 are designed with internal ESD diodes for protection. These diodes also set the voltage boundary of the terminal operating voltages. Positive signals present on Terminal A, Terminal B, or Terminal W that exceed $V_{D D}$ are clamped by the forward-biased diode. There is no polarity constraint between $V_{A}, V_{W}$, and $V_{B}$, but they cannot be higher than $V_{D D}$ or lower than GND.


Figure 49. Maximum Terminal Voltages Set by $V_{D D}$ and GND
$D B[6: 3]$ is $1010=10$
$\mathrm{DB}[2: 0]$ is $010=2 \times 2^{-3}=0.25$

## THEORY OF OPERATION

## POWER-UP SEQUENCE

Because there are diodes to limit the voltage compliance at Terminal A, Terminal B, and Terminal W (Figure 49), it is important to power $V_{D D}$ first before applying any voltage to Terminal $A$, Terminal B, and Terminal W. Otherwise, the diode is forward-biased such that $V_{D D}$ is powered unintentionally. The ideal power-up sequence is $G N D, V_{D D}, V_{\text {LOGIC }}$, digital inputs, and $V_{A}, V_{B}$, and $V_{W}$. The order of powering $V_{A}, V_{B}, V_{W}$, and digital inputs is not important as long as they are powered after $V_{D D}$ and $V_{\text {LOGIC. }}$. Regardless of the power-up sequence and the ramp rates of the power supplies, once $V_{\text {LOGIC }}$ is powered, the power-on preset activates, which restores EEPROM values to the RDAC registers.

## LAYOUT AND POWER SUPPLY BIASING

It is always a good practice to use compact, minimum lead length layout design. The leads to the input should be as direct as possible with a minimum conductor length. Ground paths should have low resistance and low inductance. It is also good practice to bypass the power supplies with quality capacitors. Low equivalent series resistance (ESR) $1 \mu \mathrm{~F}$ to $10 \mu \mathrm{~F}$ tantalum or electrolytic capacitors should be applied at the supplies to minimize any transient disturbance and to filter low frequency ripple. Figure 50 illustrates the basic supply bypassing configuration for the AD5110/AD5112/ AD5114.


Figure 50. Power Supply Bypassing

## OUTLINE DIMENSIONS



Figure 51. 8-Lead Frame Chip Scale Package [LFCSP]
$2.00 \mathrm{~mm} \times 2.00 \mathrm{~mm}$ Body and 0.55 mm Package Height
(CP-8-10)
Dimensions shown in millimeters
Updated: November 17, 2021

## ORDERING GUIDE

| Model ${ }^{1}$ | Temperature Range | Package Description | Packing Quantity | Package Option | Marking Code |
| :---: | :---: | :---: | :---: | :---: | :---: |
| AD5110BCPZ10-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP (2mm x 2mm w/ EP) | Reel, 3000 | CP-8-10 | 8V |
| AD5110BCPZ10-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 8 V |
| AD5110BCPZ10-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 8 V |
| AD5110BCPZ80-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 -Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 8 X |
| AD5110BCPZ80-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 8 X |
| AD5110BCPZ80-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 8 X |
| AD5112BCPZ10-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7L |
| AD5112BCPZ10-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 7L |
| AD5112BCPZ10-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7L |
| AD5112BCPZ5-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7P |
| AD5112BCPZ5-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 7P |
| AD5112BCPZ5-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7P |
| AD5112BCPZ80-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7R |
| AD5112BCPZ80-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 7R |
| AD5112BCPZ80-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 7R |
| AD5114BCPZ10-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 81 |
| AD5114BCPZ10-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 81 |
| AD5114BCPZ10-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 81 |
| AD5114BCPZ80-1-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8 -Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 83 |
| AD5114BCPZ80-500R7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 500 | CP-8-10 | 83 |
| AD5114BCPZ80-RL7 | $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead LFCSP ( $2 \mathrm{~mm} \times 2 \mathrm{~mm}$ w/ EP) | Reel, 3000 | CP-8-10 | 83 |

${ }^{1} Z=$ RoHS Compliant Part.

## $R_{A B}(K \Omega)$, RESOLUTION, AND $I^{2} C$ ADDRESS OPTIONS

| Model $^{1}$ | $\mathrm{R}_{\mathrm{AB}}(\mathrm{k} \Omega)$ | Resolution | I $^{2} \mathrm{C}$ Address |
| :--- | :--- | :--- | :--- |
| AD5110BCPZ10-1-RL7 | 10 | 128 | 0101100 |
| AD5110BCPZ10-500R7 | 10 | 128 | 0101111 |
| AD5110BCPZ10-RL7 | 10 | 128 | 0101111 |

## OUTLINE DIMENSIONS

| Model ${ }^{1}$ | $\mathrm{R}_{\mathrm{AB}}(\mathrm{k} \Omega)$ | Resolution | I $^{2} \mathrm{C}$ Address |
| :--- | :--- | :--- | :--- |
| AD5110BCPZ80-1-RL7 | 80 | 128 | 0101100 |
| AD5110BCPZ80-500R7 | 80 | 128 | 0101111 |
| AD5110BCPZ80-RL7 | 80 | 128 | 0101111 |
| AD5112BCPZ10-1-RL7 | 10 | 64 | 0101100 |
| AD5112BCPZ10-500R7 | 10 | 64 | 0101111 |
| AD5112BCPZ10-RL7 | 10 | 64 | 0101111 |
| AD5112BCPZ5-1-RL7 | 5 | 64 | 0101100 |
| AD5112BCPZ5-500R7 | 5 | 64 | 0101111 |
| AD5112BCPZ5-RL7 | 8 | 64 | 0101111 |
| AD5112BCPZ80-1-RL7 | 80 | 64 | 0101100 |
| AD5112BCPZ80-500R7 | 80 | 64 | 0101111 |
| AD5112BCPZ80-RL7 | 10 | 64 | 0101111 |
| AD5114BCPZ10-1-RL7 | 10 | 32 | 0101100 |
| AD5114BCPZ10-500R7 | 10 | 32 | 0101111 |
| AD5114BCPZ10-RL7 | 80 | 32 | 0101111 |
| AD5114BCPZ80-1-RL7 | 80 | 32 | 0101100 |
| AD5114BCPZ80-500R7 | 80 | 32 | 0101111 |
| AD5114BCPZ80-RL7 |  |  | 0101111 |

1 Z = RoHS Compliant Part.

## EVALUATION BOARDS

Model ${ }^{1,2} 2$
EVAL-AD5110SDZ
$1 \mathrm{Z}=$ RoHS Compliant Part.
2 The EVAL-AD5110SDZ has an $\mathrm{R}_{\mathrm{AB}}$ of $10 \mathrm{k} \Omega$.
${ }^{2} C$ refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

